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(54) **ACOUSTIC WAVE DEVICE AND METHOD  
FOR MANUFACTURING ACOUSTIC WAVE  
DEVICE**

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(57) **ABSTRACT**

An acoustic wave device includes a support substrate including a hollow portion, a piezoelectric layer laminated on the support substrate and including a membrane portion at least partially overlapping the hollow portion in a lamination direction, and an electrode on the piezoelectric layer. The electrode includes an IDT electrode finger and an electrode portion other than the IDT electrode finger. The IDT electrode finger is provided on the membrane portion, and an outer contour of the electrode portion intersects with a boundary of the membrane portion in plan view.

